

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOSHIMITSU TSURUGA	02/26/2014
KENJI TAKEUCHI	02/26/2014
MANABU MOTEGI	02/26/2014
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14173392
CORRESPONDENCE DATA	
Fax Number:	
Phone:	202-434-1500
Email:	ptomail@s-n-h.com
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>	
Correspondent Name:	STAAS & HALSEY LLP
Address Line 1:	SUITE 700
Address Line 2:	1201 NEW YORK AVENUE, N.W.
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20005
ATTORNEY DOCKET NUMBER:	2294.1948
NAME OF SUBMITTER:	GREGORY W. HARPER
Signature:	/Gregory W. Harper/
Date:	02/27/2014
Total Attachments: 1 source=Assignment#page1.tif	

U.S. ASSIGNMENT

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IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

(Insert Name(s) & Address(es) of ASSIGNEE(S))

SAMSUNG ELECTRONICS CO., LTD.
129, Samsung-ro, Yeongtong-gu,
Suwon-si, Gyeonggi-do 443-742
Republic of Korea

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest in the invention entitled
(Title of Invention)

VACUUM INSULATION MATERIAL, INSULATION CASE UNIT, AND REFRIGERATOR

relating to International Patent Application PCT/_____/_____, and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on ;

(Insert date of execution of application, if not concurrent)

(b) filed on , February 5, 2014

Serial No. 14/173,392;

Any registered attorney or patent agent of STAAS & HALSEY LLP,
1201 New York Avenue, N.W., Suite 700 Washington, D.C. 20006
(202)434-1500 is hereby authorized to insert in (b) the specified
data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

(Date)

(Typed Name & Signature of Witness(es))

1) Toshimitsu Tsuruga Feb. 26, 2014
Toshimitsu TSURUGA

2) Kenji Takeuchi Feb. 26, 2014
Kenji TAKEUCHI

3) Manabu Motesi Feb. 26, 2014
Manabu MOTESI